

ALTERNATION HISTORY RECORDS 变更记录

Date 日期	Version 版本	Mark 标记	Page 页码	Description 描述	Drafter 制定者	Approver 审批者
2019-05-10	B	/	/	In release 换版发行	余大光	彭旭

1. Part Numbering System):

CR	03	J	A	10K
<u>Series Name</u> Chip Resistor: CR: Thick Film chip resistors	<u>Type</u> Inch (mm) 02-0402(1005) 03-0603(1608) 05-0805(2012) 06-1206(3216)	<u>Tolerance</u> B= ± 0.1% D= ± 0.5 % F= ± 1% J= ± 5 % P : Jumper	<u>Package</u> A=4Kpcs/7"Reel B=5Kpcs/7"Reel C=10Kpcs/7"Reel M=15Kpcs/7"Reel D=10Kpcs/10"Reel E=20Kpcs/10"Reel	<u>Resistance</u> 1R2=1.2Ω 10K=10KΩ 10K5=10.5KΩ 100K=100KΩ 1M2=1.2MΩ

2. FEATURE

- High reliability and stability
- Reduced size of final equipment
- Lower assembly costs
- Higher component and equipment reliability
- RoHS 2 compliant and Halogen free products

3. APPLICATION

- Consumer electrical equipment
- EDP, Computer application
- Telecom application

4. DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

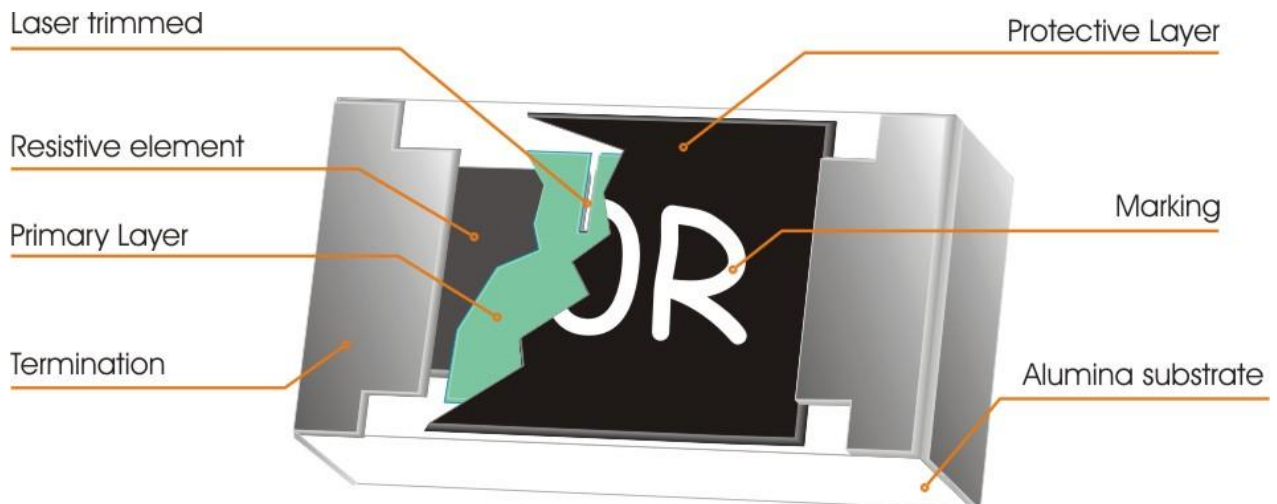


Fig 1. Construction of Chip-R

5. QUICK REFERENCE DATA

Item	General Specification							
Series No.	CR06		CR05		CR03		CR02	
Size code	1206		0805		0603		0402	
Resistance Range	1Ω~10MΩ (±5% tolerance), Jumper 1Ω~10MΩ (±1% tolerance), 10Ω ~ 1MΩ (±0.5%, ±0.1% tolerance)							
Resistance Tolerance	E96/E24	E24	E96/E24	E24	E96/E24	E24	E96/E24	E24
TCR (ppm/°C) 10MΩ ≥R > 10Ω R ≤ 10Ω	≤ ± 100 -200~+400							
Max. dissipation @ T _{amb} =70°C	1/4 W		1/8 W		1/10 W		1/16 W	
Max. Operation Voltage (DC or RMS)	200V		150V		75V		50V	
Max. Overload Voltage (DC or RMS)	400V		300V		150V		100V	
Operating Temperature	-55 ~ +155°C							

TEST CONDITION FOR JUMPER (0 Ω)

Item	CR06	CR05	CR03	CR02
Power Rating At 70°C	1/4W	1/8W	1/10W	1/16W
Resistance	MAX.50mΩ			
Rated Current	2A	1.5A	1A	1A
Peak Current	5A	3.5A	3A	2A
Operating Temperature	-55 ~ +155°C			

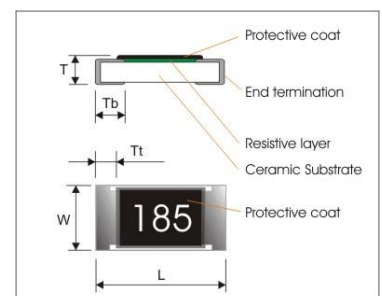
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}} \text{ or Max. RCWV listed above, whichever is lower.}$$

6.DIMENSIONS (unit : mm)

	CR06	CR05	CR03	CR02
L	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10	1.00 ± 0.05
W	1.60 ± 0.10	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
T	0.60 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.35 ± 0.05
Tb	0.45 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.25 ± 0.10
Tt	0.50 ± 0.20	0.40 ± 0.20	0.30 ± 0.10	0.20 ± 0.10



7.FUNCTIONAL DESCRIPTION

7.1 Product characterization

Standard values of nominal resistance are taken from the E24&E96 series for resistors with a tolerance of $\pm 0.1\%$, $\pm 0.5\%$, $\pm 1\%$, $\pm 5\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063"

7.2 Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

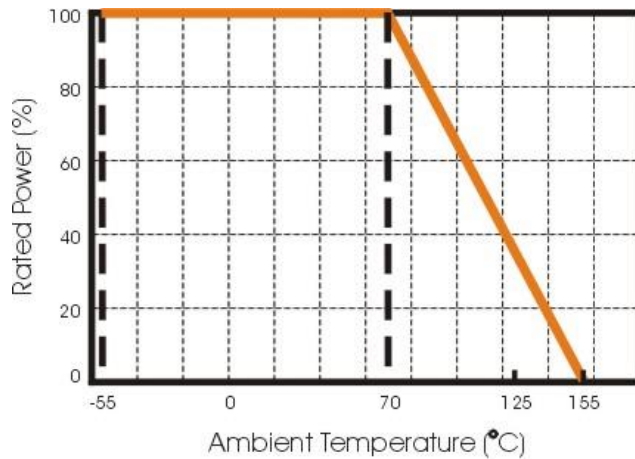


Figure 2 Maximum dissipation in percentage of rated power as a function of the ambient temperature for CR06 , CR05, CR03, CR02

7.3 Storage and Handling Conditions:

1. Products are recommended to be used up within two years since operation date as ensured shelf life. Check solderability in case shelf life extension is needed.
2. To store products with following condition:
Temperature :5 to 40°C
Humidity :20 to 70% relative humidity
3. Caution:
 - a. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid.
It may cause oxidization of electrode, which easily be resulted in poor soldering
 - b. To store products on the shelf and avoid exposure to moisture.
 - c. Don't expose products to excessive shock, vibration, direct sunlight and so on

7.4 SOLDERING CONDITION follows J-STD-020D

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

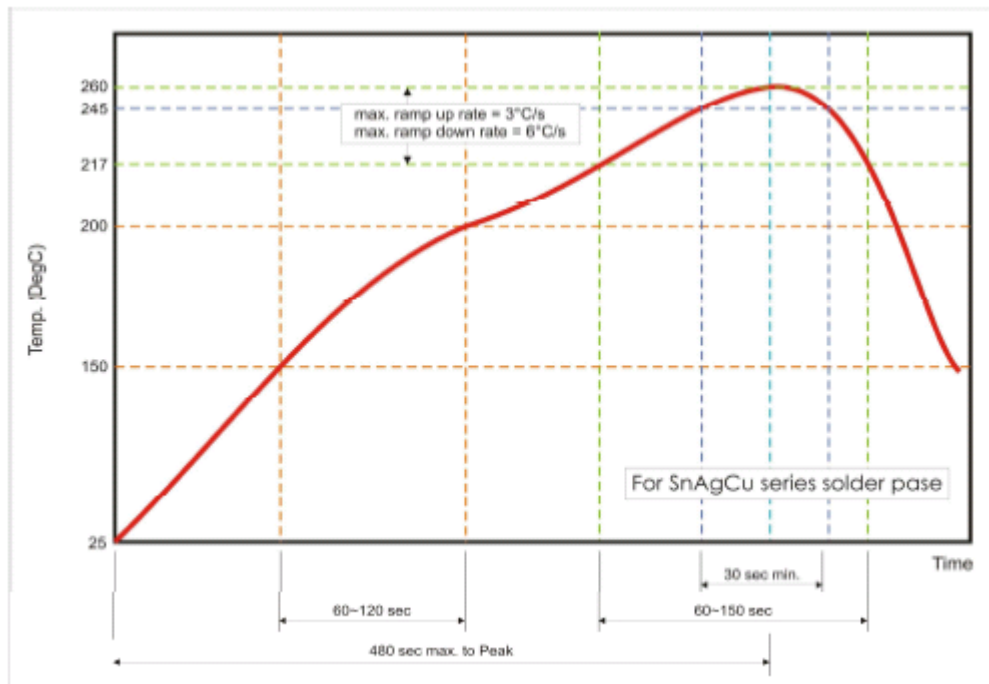


Fig 3. Infrared soldering profile for Chip Resistors

7.5 TEST AND REQUIREMENTS

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category **LCT/UCT/56**(rated temperature range : **L**ower **C**ategory **T**emperature, **U**pper **C**ategory **T**emperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

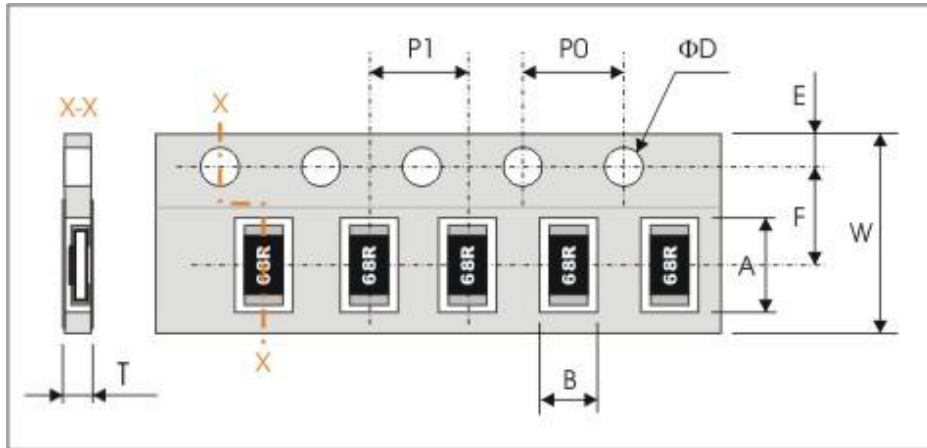
Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with mildly activated flux.

TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	0Ω
Electrical Characteristics JISC5201-1: 1998 Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/}^\circ\text{C)}$ $t_1 : 20^\circ\text{C}+5^\circ\text{C}-1^\circ\text{C}; t_2 : -55^\circ\text{C or }+155^\circ\text{C}$ R_1 : Resistance at reference temperature (20°C+5°C/-1°C) R_2 : Resistance at test temperature (-55°C or +155°C)	Within the specified tolerance Refer to "QUICK REFERENCE DATA"	<50mΩ
Resistance to soldering heat(R.S.H) JISC5201-1:1998 Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C ±5°C	±5%:ΔR/Rmax.±(1%+0.05Ω) ±1%:ΔR/Rmax.±(0.5%+0.05Ω) no visible damage	<50mΩ
Solderability JISC5201-1: 1998 Clause 4.17	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235°C ±5°C	95% coverage min., good tinning and no visible damage	
Temperature cycling JISC5201-1: 1998 Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	±5%: ΔR/R max. ±(1%+0.05Ω) ±1%:ΔR/Rmax.±(0.5%+0.05Ω) No visible damage	<50mΩ
High Temperature Exposure MIL-STD-202 method 108	1000+48/-0 hours; without load in a temperature chamber controlled 155±3°C	±5%:ΔR/Rmax.±(2%+0.1Ω) ±1%:ΔR/Rmax.±(1%+0.1Ω) No visible damage	<50mΩ
Bending strength JISC5201-1: 1998 Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec, 5mm for CR02	±5%:ΔR/Rmax.±(1%+0.05Ω) ±1%:ΔR/Rmax.±(1%+0.05Ω) No visual damaged	<50mΩ
Adhesion JISC5201-1: 1998 Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations	
Short Time Overload (STOL) JISC5201-1: 1998 Clause 4.13	2.5 times RCWV or max. overload voltage, for 5seconds	±5%: ΔR/R max. ±(2%+0.05Ω) ±1%: ΔR/R max. ±(1%+0.05Ω) No visible damage	<50mΩ
Load life in Humidity JISC5201-1: 1998 Clause 4.24	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	±5%: ΔR/R max. ±(2%+0.1Ω) ±1%: ΔR/R max. ±(1%+0.1Ω) No visible damage	<50mΩ
Load life (endurance) JISC5201-1: 1998 Clause 4.25	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	±5%: ΔR/R max. ±(3%+0.1Ω) ±1%: ΔR/R max. ±(1%+0.1Ω) No visible damage	<50mΩ
Insulation Resistance JISC5201-1: 1998 Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R ≥ 10GΩ	
Dielectric Withstand Voltage JISC5201-1: 1998 Clause 4.7	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover	

8.PACKAGING

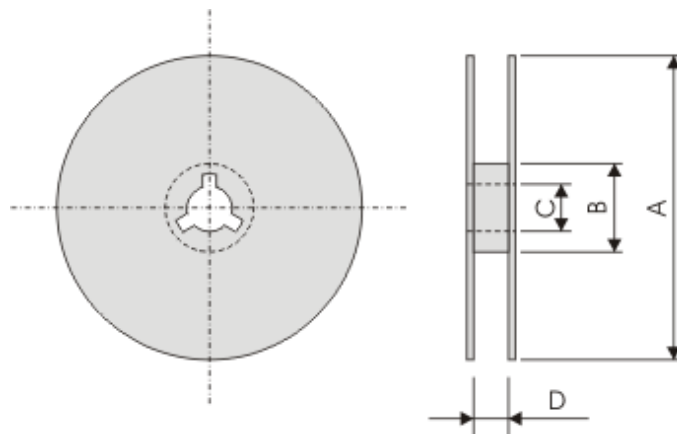
8.1 Paper Tape specifications (unit :mm)



Series No.	A	B	W	F	E
CR06	3.60±0.20	2.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10
CR05	2.40±0.20	1.65±0.20			
CR03	1.90±0.20	1.10±0.20			
CR02	1.20±0.10	0.70±0.10			

Series No.	P1	P0	ΦD	T
CR06/CR05	4.00±0.10	4.00±0.10	Φ1.50 ^{+0.1} _{-0.0}	Max. 1.0
CR03				0.65±0.05
CR02	2.00±0.10			0.40±0.05

8.2 Reel dimensions



Symbol	A	B	C	D
7" reel	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5
10" reel	Φ254.0±2.0	Φ100.0±1.0	13.0±0.2	9.0±0.5
13" reel	Φ330.0±2.0	Φ100.0±1.0	13.0±0.2	9.0±0.5

8.3 Taping Quantity:

Tape	Paper Tape						Embossed Tape	Bulk Cassette
	4mm pitch			2mm pitch			4mm pitch	
	7"	10"	13"	7"	10"	13"	7"	
0201	-	-	-	15000	-	-	-	-
0402	-	-	-	10000	20000	40000	-	50000
0603	5000	10000	20000	10000	20000	-	-	20000
0805	5000	10000	20000	-	-	-	-	10000
1206	5000	10000	20000	-	-	-	-	5000

9. Performance of Taping :

9.1. Strength of Carrier Tape and Top Cover Tape

-Carrier Tape

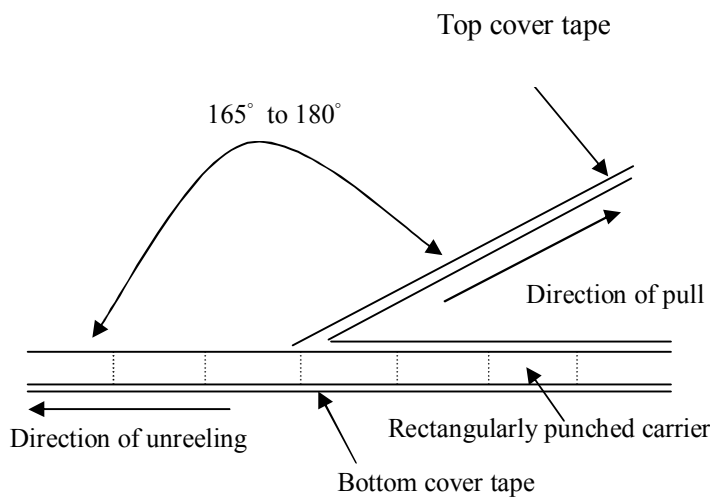
When a tensile force 1.02kgf is applied in the direction of unreeling the tape, the tape shall withstand this force.

-Top cover Tape

When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force.









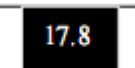

9.2 Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10.2 to 71.4 g f when the top cover tape is pulled at a speed of 300mm/min with the angle between the taped during peel and the direction of unreeling maintained at 165 to 180° as illustrated in Fig.



10. Resistance Marking Explanation:

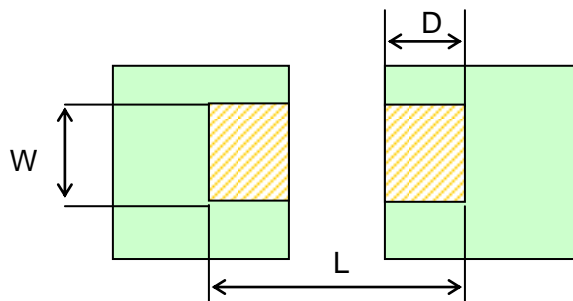
1206 (3216)	3-digits marking	4-digits marking
0805 (2012)	3-digits marking	4-digits marking
0603 (1608)	3-digits marking	3-digits marking
0402(1005)	NO MARKING	

Size	E-24	E-96
Jumper Series		
0402 No marking Series		
0603		
0805		
1206		

Example

RESISTANCE	10Ω	12Ω	100Ω	6800Ω	47000Ω
3-digits marking	100	120	101	682	473
4-digits marking	10R0	12R0	1000	6801	4702

11. Recommended Solder Pad Dimensions



Type	W (mm)	L (mm)	D (mm)
01(0201)	0.25~0.3	0.7~0.9	0.3~0.4
02(0402)	0.5~0.6	1.4~1.6	0.4~0.6
03(0603)	0.7~0.9	2.0~2.2	0.8~1.0
05(0805)	1.0~1.4	3.2~3.8	0.9~1.4
06(1206)	2.0~2.4	4.4~5.0	1.2~1.8
10(1210)	2.0~2.4	4.4~5.0	2.3~3.5
0A(2010)	3.3~3.7	5.7~6.5	2.3~3.5
12(2512)	3.6~4.0	7.8~8.6	2.3~3.5

Note :

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.